Power MOSFET 100V, 2.8mΩ, 180A, N-Channel



ON Semiconductor®

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RDS(on) Max

2.8mΩ@ 15V

3.3mΩ@ 10V

Electrical Connection

N-Channel

2.4

3

TO-263

CASE 418AJ

ID Max

180A

1 : Gate 2 : Drain 3 : Source 4 : Drain

Marking

180N10 O B [LOT No.]

VDSS

100V

Features

- Ultra Low On-Resistance
- Low Gate Charge
- High Speed Switching
- 100% Avalanche Tested
- Pb-Free, Halogen Free and RoHS compliance

Specifications

Absolute Maximum Ratings at Ta = 25°C (Note 1)

Parameter	Symbol	Value	Unit
Drain to Source Voltage	V _{DSS}	100	V
Gate to Source Voltage	V _{GSS}	±20	V
Drain Current (DC)	ID	180	А
Drain Current (DC) Limited by Package	IDL	100	А
Drain Current (Pulse) PW≤10µs, duty cycle≤1%	IDP	600	A
Power Dissipation Tc=25°C	PD	200	W
Junction Temperature	Tj	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Source Current (Body Diode)	IS	100	А
Avalanche Energy (Single Pulse) (Note 2)	EAS	451	mJ
Lead Temperature for Soldering Purposes, 3mm from Case for 10 Seconds	ΤL	260	°C

Note 1 : Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2 : VDD=48V, L=100µH, IAV=70A (Fig.1)

Thermal Resistance Ratings

Parameter	Symbol	Value	Unit	
Junction to Case Steady State	$R_{\theta JC}$	0.75	°C/W	
Junction to Ambient (Note 3)	$R_{\theta JA}$	62.5		

Note 3 : Surface mounted on FR4 board using recommended footprint

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

Electrical Characteristics at $Ta = 25^{\circ}C$ (Note 4)

Deservator	Cumb al	Conditions	Value			
Parameter	Symbol	Conditions	min	typ	max	Uni
Drain to Source Breakdown Voltage	V(BR)DSS	I _D =10mA, V _{GS} =0V	100			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =100V, V _{GS} =0V			10	μA
Gate to Source Leakage Current	IGSS	V _{GS} =±20V, V _{DS} =0V			±200	nA
Gate Threshold Voltage	V _{GS} (th)	V _{DS} =10V, I _D =1mA	2		4	V
Forward Transconductance	9FS	V _{DS} =10V, I _D =50A		150		S
Static Drain to Source On-State Resistance	R _{DS} (on)1	I _D =50A, V _{GS} =15V		2.3	2.8	mΩ
	R _{DS} (on)2	I _D =50A, V _{GS} =10V		2.5	3.3	mΩ
Input Capacitance	Ciss			6,950		pF
Output Capacitance	Coss	V _{DS} =50V, f=1MHz		3,000		pF
Reverse Transfer Capacitance	Crss			15		pF
Turn-ON Delay Time	t _d (on)			95		ns
Rise Time	tr			320		ns
Turn-OFF Delay Time	t _d (off)	See Fig.2		185		ns
Fall Time	tf			130		ns
Total Gate Charge	Qg			95		nC
Gate to Source Charge	Qgs	V _{DS} =48V, V _{GS} =10V, I _D =100A		31		nC
Gate to Drain "Miller" Charge	Qgd]		26		nC
Forward Diode Voltage	V _{SD}	I _S =100A, V _{GS} =0V		0.9	1.5	V
Reverse Recovery Time	t _{rr}	See Fig.3		150		ns
Reverse Recovery Charge	Q _{rr}	I _S =100A, V _{GS} =0V, V _{DD} =50V, di/dt=100A/µs 580			nC	
Reverse Recovery Charge	Q _{rr}	I _S =100A, V _{GS} =0V, V _{DD} =50V, di/dt=100A/µs		580		nC

Note 4 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Fig.1 Unclamped Inductive Switching Test Circuit

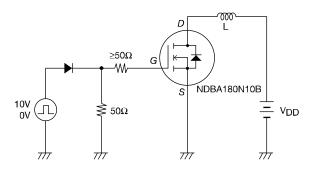


Fig.3 Reverse Recovery Time Test Circuit

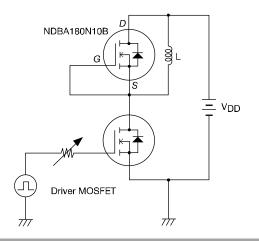
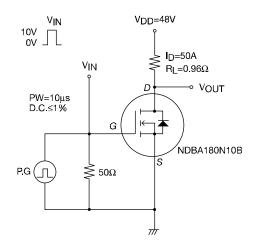
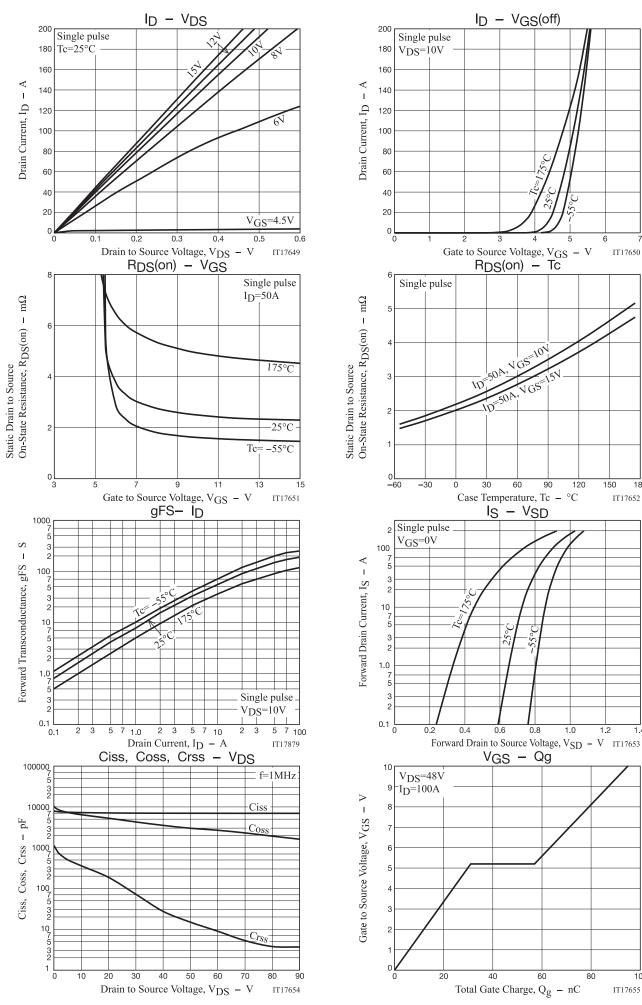


Fig.2 Switching Time Test Circuit



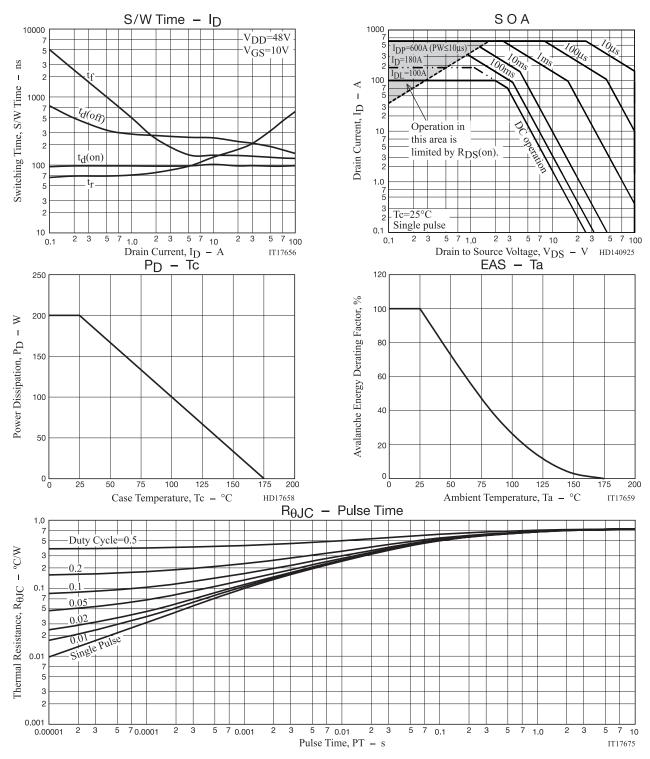


180

1.4

100

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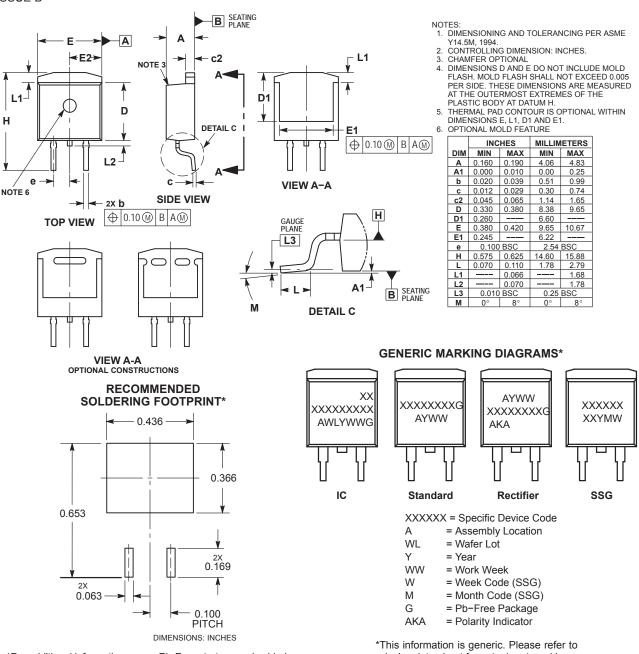


Package Dimensions

unit : mm

D²PAK-3 (TO-263, 3-LEAD) CASE 418AJ

ISSUE B



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present.

ORDERING INFORMATION

Device	Package	Shipping	Note
NDBA180N10BT4H	D ² PAK-3 (TO-263, 3-LEAD)	800 pcs. / Tape & Reel	Pb-Free and Halogen Free

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage : Since the NDBA180N10B is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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